

EDCON-COMPONENTS



Designed for surface mounting on high density circuit board

Emboss carrier tape packing systems is available for automatic insertion



Technical Informations

Voltage:	10Volt
Range:	150µF
Dimension; D x L mm	6,3x5,4mm
Impedance (Ω) max., at20°C, 100hKz	no specified
Ripple Current (mA rms) at 105°C, 100kHz	62mA

Ordering Code			
100	Voltage		
151	Range		
D=	C	L=	0

Operating Temperatur Range of -40°C ~ +85°C

Load Life of 1000~2000 hours at 85°C

Leakage current max.	Ø4 ~ Ø10mm	I= 0,01CV or 3µA whichever is greater (after 2 minutes)									
	Ø12,5 ~ Ø16mm	I= 0,03CV or 4µA whichever is greater (after 1 minutes)									
Capacitance tolerance	± 20% at 120Hz, 20°C										
Dissipation factor max. (at 120Hz, 20°C)	WV		4,0	6,3	10	16	25	35	50	63	100
	Tanδ	Ø4 ~ Ø10mm	0,42	0,30	0,26	0,22	0,16	0,14	0,21	0,12	0,12
		Ø12,5 ~ Ø16mm	0,45	0,38	0,34	0,30	0,26	0,22	0,18	0,14	0,12

Low Temperatur characteristics (Impedance ratio at 120Hz)	WV		4,0	6,3	10	16	25	35	50	63	100
	Ø4 ~ Ø10mm	Z-25°C / Z+20°C	7	4	3	2	2	2	2	2	2
		Z-40°C / Z+20°C	15	8	6	4	4	3	3	3	4
	Ø12,5 ~ Ø16mm	Z-25°C / Z+20°C	7	5	4	3	2	2	2	2	2
Z-40°C / Z+20°C		17	12	10	8	5	4	3	3	3	

Load Life (after aplication of the rated voltage for 1000hrs at 105°C	Leakage current	Less than specified value									
	Capacitance Change	Within ±20% of initial value									
		Within ±30% of initial value for 4V & 6,3V									
	Tanδ	Less than 200% of specified value									
Shell life (at 85°C)	After 1000hours no load test, leakage current, capacitance and tanδ are same as load life value.										

CHIP Wide Temperature Range 105°C

Part No.: **I15005**

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		2 from 7

Customer:

EDCON-COMPONENTS



Designed for surface mounting on high density circuit board
 Emboss carrier tape packing systems is available for automatic insertion



Resistance to soldering heat	After reflow soldering and resistance at room temperature, they meet the characteristics requirements listed at underside	
	Leakage current	Less than specified value
	Capacitance Change	Within $\pm 10\%$ of initial value
	Tan δ	Less than specified value

FREQUENCY COEFFICIENT OF PERMISSIBLE RIPPLE CURRENT						
Diameter	Capacitance	Frequency				
	μF	50Hz	120Hz	300Hz	1KHz	10KHz \leq
$\varnothing 4 \sim \varnothing 10\text{mm}$	0,1 ~68	0,70	1,00	1,17	1,36	1,50
	100 ~3300	0,85	1,00	1,08	1,20	1,30
$\varnothing 12,5 \sim \varnothing 16\text{mm}$	~68	0,75	1,00	1,35	1,57	2,00
	100 ~680	0,80	1,00	1,23	1,34	1,50
	1000 ~6800	0,85	1,00	1,10	1,13	1,15

CHIP Wide Temperature Range 105°C	
Part No.:	I15005
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		3 from 7

EDCON-COMPONENTS



Designed for surface mounting on high density circuit board
 Emboss carrier tape packing systems is available for automatic insertion



Technical Drawing

Dimension of Size Ø 8x10,5 ~ 16mm



Dimension of Size Ø 4~ 8x6,2mm



D x L	Ø 4 x 5,4	Ø 5 x 5,4	Ø 6,3 x 5,4	Ø 6,3 x 7,7	Ø 8 x 6,2	Ø 8 x 10,5	Ø 10 x 10,5	Ø 10 x 13,5	Ø 12,5 x 13,5	Ø 12,5 x 16	Ø 16 x 16,5
A	1,8	2,1	2,4	2,4	3,3	2,9	3,2	3,2	4,7	4,7	5,5
B	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
C	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
E +/-0.2	1,0	1,3	2,2	2,2	2,2	3,1	4,4	4,4	4,4	4,4	6,7
L	5,4	5,4	5,4	7,7	6,2	10,5	10,5	13,5	13,5	16,0	16,5

*1 Voltage mark (6V) represents 6,3V for Ø 4 ~ 10mm

*3 (L +/- 0.5) is applicable to Ø 8x10,5 ~ Ø 10mm

*2 (L +/- 0.3) is applicable to Ø 6,3 ~ 7.7 and Ø 8 + 6,2mm

*4 (L +/- 1.0) is applicable to Ø 12,5 ~ Ø 16mm

RE. Date code and seriew type -1st digit for Year 2nd digit for Quarter, 4 quarter codes in one year area 1,4,7,0
 3rd character for Serie S

**CHIP Wide Temperature
 Range 105°C**

Part No.: **I15005**

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		4 from 7

Customer:

EDCON-COMPONENTS



Designed for surface mounting on high density circuit board

Emboss carrier tape packing systems is available for automatic insertion



Ordering Informations

Serie	Voltage Code	Tolerance Code	Range Code	Size Code D	Size Code L	Special function	ROHS	Packing Code		
-------	--------------	----------------	------------	-------------	-------------	------------------	------	--------------	--	--

I15005	100	M	151	C	0	XX	R	TR		
---------------	------------	----------	------------	----------	----------	-----------	----------	-----------	--	--

look table	M= ±20%	Ordering Code Range	Look table Code D	Look table Code L	XX= No function	R= ROHS Conform N= NON ROHS Conform	TR= Tape Reel Packing BU= Bulk-Ware		
Voltage Code									

CHIP Wide Temperature Range 105°C	
Part No.:	I15005
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		6 from 7

EDCON-COMPONENTS



Designed for surface mounting on high density circuit board
 Emboss carrier tape packing systems is available for automatic insertion



Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



CHIP Wide Temperature Range 105°C	
Part No.:	I15005
Customer:	

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		7 from 7